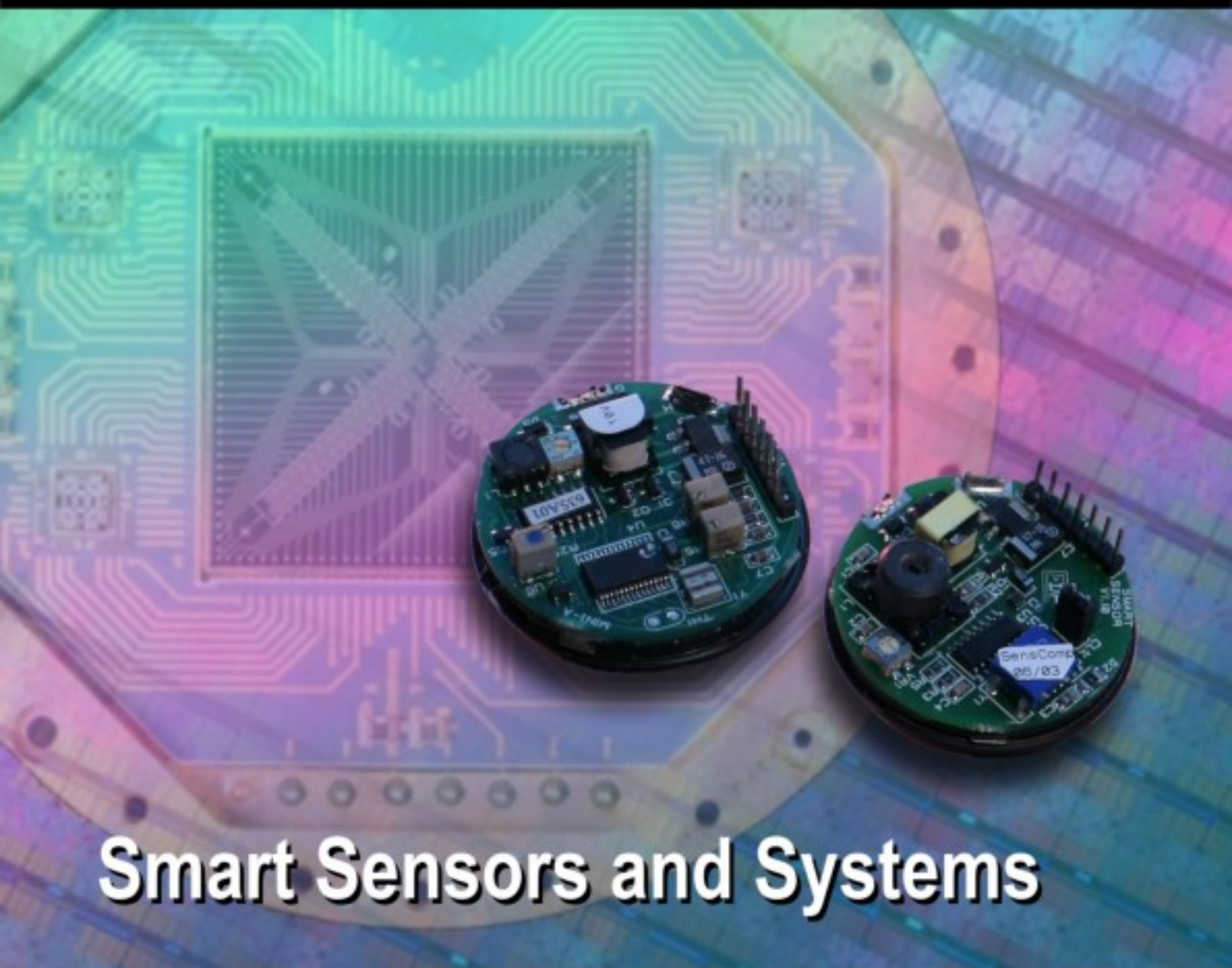


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Contents

Volume 102
Issue 3
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Research Articles

Smart Sensor Systems: Book Review	I
Design of a Smart and High Precision Industrial Temperature Measurement and Monitoring System Using K-type Thermocouple and SPI-compatible Temperature Sensor <i>Utpal Sarma, Digbijoy Chakraborty, P. K. Boruah</i>	1
IEEE 1451.0-2007 Compatible Smart Sensor Readout with Error Compensation Using FPGA <i>J. Kamala and B. Umamaheswari</i>	10
Predicting the Deflections of Micromachined Electrostatic Actuators Using Artificial Neural Network (ANN) <i>Hing Wah Lee, Mohd. Ismahadi Syono and Ishak Hj. Abd. Azid</i>	22
Conception and Development of a Portable Electronic Nose System for Classification of Raw Milk Using Principal Component Analysis Approach <i>Hing Wah Lee, Mohd. Ismahadi Syono and Ishak Hj. Abd. Azid</i>	33
Viscosity Measurement Using Microcontroller to Study the Thermal Degradation of Edible Oil <i>Neelameagam Periyasamy, Rubalya Valantina Sathianathan and Murugananthan Krishnamoorthy</i>	45
Problems of Terminology in the Field of Measuring Instruments with Elements of Artificial Intelligence <i>Roald Taymanov, Ksenia Sapozhnikova</i>	51
Microcontroller Based Closed Loop PMDC Motor Position Control System <i>Subrata Chattopadhyay, Utpal Chakraborty, Arindam Bhakta and Sagarika Pal</i>	62
Discrete Time Sliding Mode Control Using Fast Output Sampling Feedback for Piezoelectric Actuated Structures <i>L. R. Karl Marx, M. Umapathy, A. Girija, D. Ezhilarasi</i>	71
A Particle Swarm Optimization of Natural Ventilation Parameters in a Greenhouse with Continuous Roof Vents <i>Abdelhafid Hasni, Belkacem Draoui, Thierry Boulard, Rachid Taibi and Brahim Dennai</i>	84
Experimental and Computational Study of Two-phase (Air–Palm Oil) Flow through Pipe and Control Valve in Series <i>Arivazhagan M., Pugalenth, Krishna Karthik K., Rani Hemamalini, Sundaram S.</i>	94
The Effect on Pressure Drop across Control Valve for Two Phase Flow (Air-Water) <i>Arivazhagan M, Krishna Karthik K, Sundaram S</i>	105
RBIC-Lite – a Family of Signal Conditioning ICs of ZMD <i>Krauss Gudrun, Krauss Mathias</i>	115

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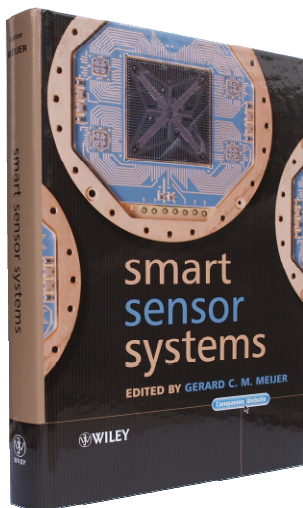
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Smart Sensor Systems: Book Review

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Published by John Wiley and Sons, *Smart Sensor Systems* (edited by Gerard C.M. Meijer) is intended as a reference for designers and users of various smart sensors and sensor systems. This book is based on material presented in the annual EuroTraining Quality Labelled Approved engineering multidisciplinary course of the same name that is given at Delft University of Technology since 1995.

Smart sensors and sensor systems are being used widely in industries, including automotive, medical, industrial, entertainment, security, and defence due to increased usage of process controls and sensing elements in different sectors. According to analytics from the *Global Industry Analysts Inc.*, Europe represents the largest and fastest growing smart sensors market and is projected to reach US\$2.1 billion by 2010, while the global smart sensors market will reach US\$7.8 billion by 2015. The past few decades

have witnessed an explosive growth in sensors and sensor-based applications, which has led to a greater demand for sensor interfacing integrated circuits. Strong growth expected for sensors based on MEMS-technologies, intelligent sensors and sensors with bus capabilities.

Writing by really stellar internationally-recognized team of experts as Johan H. Huijsing, Gerard C.M. Meijer, Paddy J. French, Reinoud F. Wolffenbuttel, Michael J. Vellekoop, Radivoje S. Popović, Sergey Y. Yurish and others, the new published book *Smart Sensor Systems* provides the reader with a deep understanding of the basic principles and concepts of advanced sensor systems starting from main definitions of sensors, smart sensors and integrated smart sensors to handling them all information necessary to develop smart sensor systems (including self-adaptive sensor systems), interface electronics and powerful measurement techniques for such systems. The book provides excellent information about many types of silicon sensors, optical sensors, physical chemosensors, thermal sensors, temperature sensors, capacitive sensors, Hall magnetic sensors as well as universal sensor interfaces, data acquisition for frequency- and time domain sensors, microcontrollers, digital signal processors, A-D converters and universal frequency-to-digital converters for smart sensor systems.

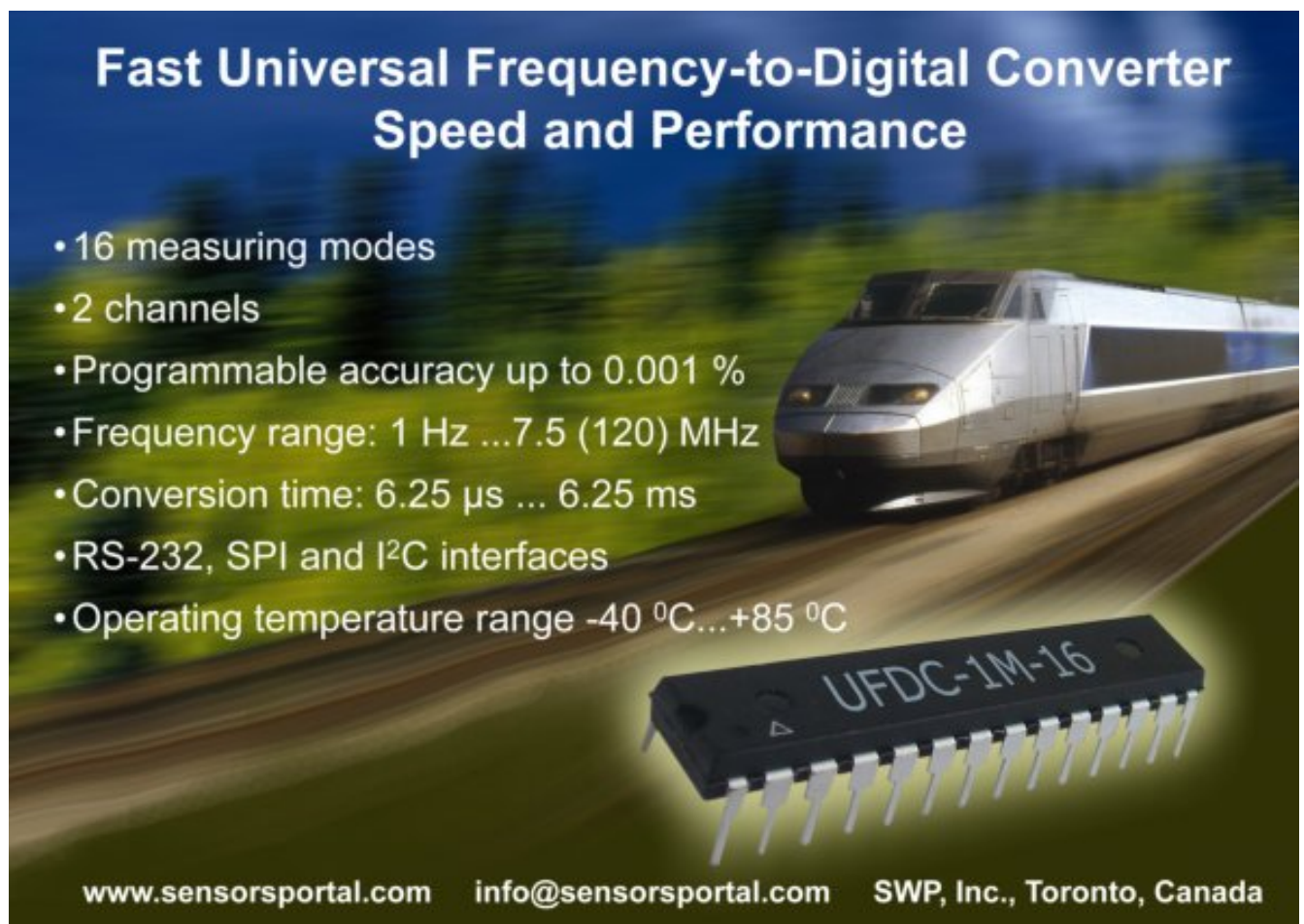
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Sensors & Transducers Journal (ISSN 1726-5479) provides an advanced forum for the science and technology of physical, chemical sensors and biosensors. It publishes state-of-the-art reviews, regular research and application specific papers, short notes, letters to Editor and sensors related books reviews as well as academic, practical and commercial information of interest to its readership. Because it is an open access, peer review international journal, papers rapidly published in *Sensors & Transducers Journal* will receive a very high publicity. The journal is published monthly as twelve issues per annual by International Frequency Association (IFSA). In addition, some special sponsored and conference issues published annually.

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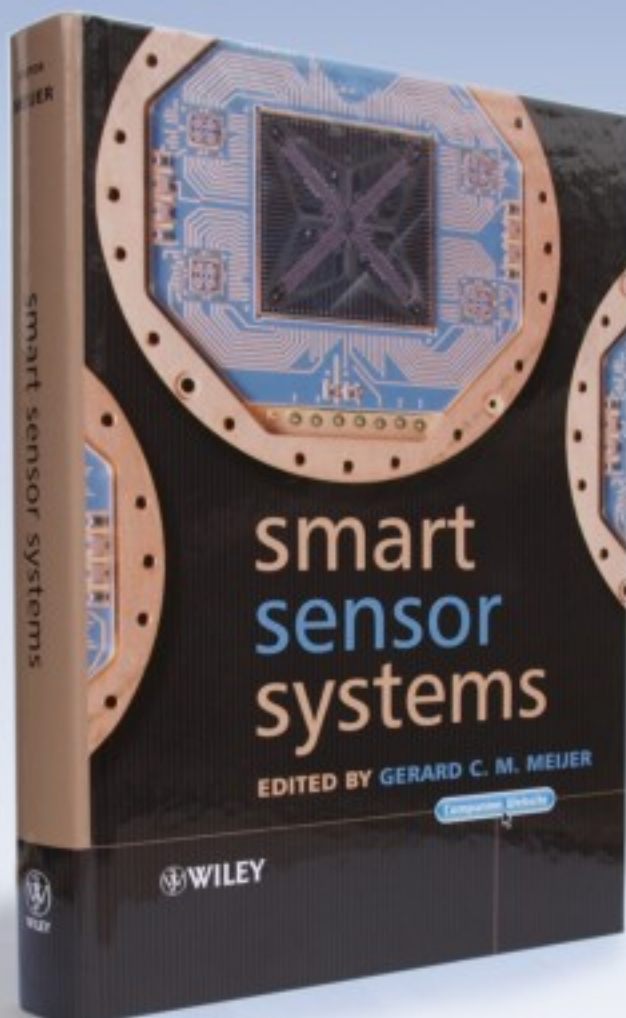
- Physical, chemical and biosensors;
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